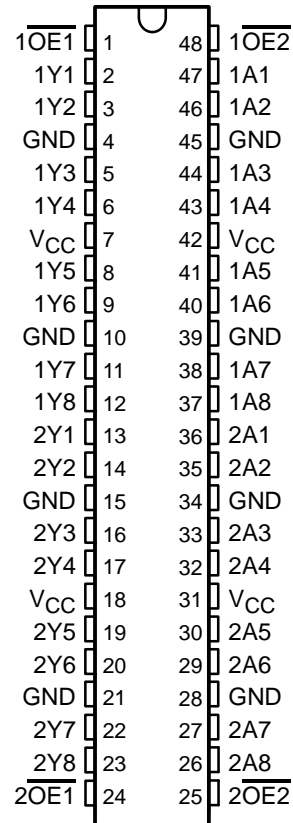


# SN54ABT162541, SN74ABT162541 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

SCBS245 – JULY 1993

- Output Ports Have Equivalent 25-Ω Series Resistors, So No External Resistors Are Required
- Members of the Texas Instruments *Widebus*™ Family
- State-of-the-Art *EPIC-II B*™ BiCMOS Design Significantly Reduces Power Dissipation
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical  $V_{OLP}$  (Output Ground Bounce) < 1 V at  $V_{CC} = 5$  V,  $T_A = 25^\circ\text{C}$
- Distributed  $V_{CC}$  and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Layout
- Packaged in Plastic 300-mil Shrink Small-Outline Packages and 380-mil Fine-Pitch Ceramic Flat Packages Using 25-mil Center-to-Center Spacings

SN54ABT162541 ... WD PACKAGE  
SN74ABT162541 ... DL PACKAGE  
(TOP VIEW)



## description

The 'ABT162541 is a noninverting 16-bit buffer composed of two 8-bit sections with separate output-enable signals. For either 8-bit buffer section, the two output-enable ( $\overline{1OE1}$  and  $\overline{1OE2}$  or  $\overline{2OE1}$  and  $\overline{2OE2}$ ) inputs must both be low for the corresponding Y outputs to be active. If either output-enable input is high, the outputs of that 8-bit buffer section are in the high-impedance state.

The outputs, which are designed to source or sink up to 12 mA, include 25-Ω series resistors to reduce overshoot and undershoot.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74ABT162541 is available in TI's shrink small-outline package (DL), which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The SN54ABT162541 is characterized for operation over the full military temperature range of  $-55^\circ\text{C}$  to  $125^\circ\text{C}$ . The SN74ABT162541 is characterized for operation from  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ .

FUNCTION TABLE  
(each 8-bit section)

INPUTS			OUTPUT
$\overline{OE1}$	$\overline{OE2}$	A	Y
L	L	L	L
L	L	H	H
H	X	X	Z
X	H	X	Z

Widebus and EPIC-II B are trademarks of Texas Instruments Incorporated.

PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.

 **TEXAS  
INSTRUMENTS**

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 1993, Texas Instruments Incorporated

PRODUCT PREVIEW

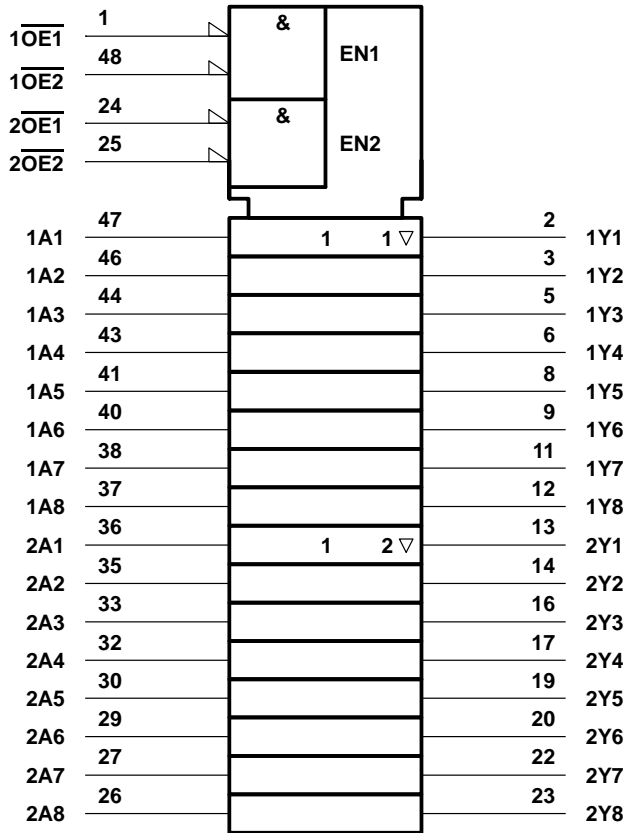
# SN54ABT162541, SN74ABT162541

## 16-BIT BUFFERS/DRIVERS

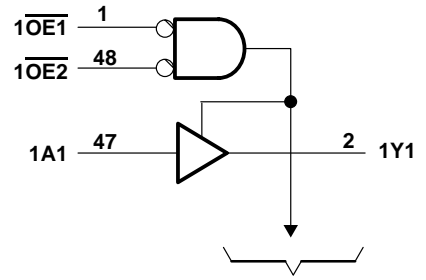
### WITH 3-STATE OUTPUTS

SCBS245 – JULY 1993

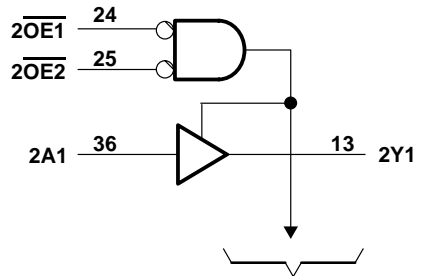
#### logic symbol†



#### logic diagram (positive logic)



To Seven Other Channels



To Seven Other Channels

PRODUCT PREVIEW

† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, $V_{CC}$ .....	-0.5 V to 7 V
Input voltage range, $V_I$ (see Note 1) .....	-0.5 V to 7 V
Voltage range applied to any output in the high state or power-off state, $V_O$ .....	-0.5 V to 5.5 V
Current into any output in the low state, $I_O$ .....	30 mA
Input clamp current, $I_{IK}$ ( $V_I < 0$ ) .....	-18 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ ) .....	-50 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) .....	0.85 W
Storage temperature range .....	-65°C to 150°C

‡ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

**SN54ABT162541, SN74ABT162541**  
**16-BIT BUFFERS/DRIVERS**  
**WITH 3-STATE OUTPUTS**

SCBS245 – JULY 1993

**recommended operating conditions (see Note 2)**

		SN54ABT162541		SN74ABT162541		UNIT
		MIN	MAX	MIN	MAX	
$V_{CC}$	Supply voltage	4.5	5.5	4.5	5.5	V
$V_{IH}$	High-level input voltage	2		2		V
$V_{IL}$	Low-level input voltage		0.8		0.8	V
$V_I$	Input voltage	0	$V_{CC}$	0	$V_{CC}$	V
$I_{OH}$	High-level output current		-12		-12	mA
$I_{OL}$	Low-level output current		12		12	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled		10	10	ns/V
$T_A$	Operating free-air temperature	-55	125	-40	85	°C

NOTE 2: Unused or floating inputs must be held high or low.

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER	TEST CONDITIONS		$T_A = 25^\circ\text{C}$			SN54ABT162541		SN74ABT162541		UNIT
			MIN	TYP†	MAX	MIN	MAX	MIN	MAX	
$V_{IK}$	$V_{CC} = 4.5\text{ V}, I_I = -18\text{ mA}$				-1.2		-1.2		-1.2	V
$V_{OH}$	$V_{CC} = 4.5\text{ V}, I_{OH} = -1\text{ mA}$		3.35			3.3		3.35		V
	$V_{CC} = 5\text{ V}, I_{OH} = -1\text{ mA}$		3.85			3.8		3.85		
	$V_{CC} = 4.5\text{ V}, I_{OH} = -3\text{ mA}$		3.1			3		3.1		
	$V_{CC} = 4.5\text{ V}, I_{OH} = -12\text{ mA}$		2.6‡					2.6		
$V_{OL}$	$V_{CC} = 4.5\text{ V}, I_{OL} = 8\text{ mA}$			0.4	0.8		0.8		0.65	V
	$V_{CC} = 4.5\text{ V}, I_{OL} = 12\text{ mA}$								0.8	
$I_I$	$V_{CC} = 5.5\text{ V}, V_I = V_{CC}\text{ or GND}$				±1		±1		±1	µA
$I_{OZH}^{\S}$	$V_{CC} = 5.5\text{ V}, V_O = 2.7\text{ V}$				50		50		50	µA
$I_{OZL}^{\S}$	$V_{CC} = 5.5\text{ V}, V_O = 0.5\text{ V}$				-50		-50		-50	µA
$I_{off}$	$V_{CC} = 0, V_I\text{ or }V_O \leq 4.5\text{ V}$				±100				±100	µA
$I_{CEX}$	$V_{CC} = 5.5\text{ V}, V_O = 5.5\text{ V}$	Outputs high			50		50		50	µA
$I_{O1}^{\parallel}$	$V_{CC} = 5.5\text{ V}, V_O = 2.5\text{ V}$		-50	-100	-180	-50	-180	-50	-180	mA
$I_{CC}$	$V_{CC} = 5.5\text{ V}, I_O = 0, V_I = V_{CC}\text{ or GND}$		Outputs high		2		2		2	mA
			Outputs low		32		32		32	
			Outputs disabled		2		2		2	
$\Delta I_{CC}^{\#}$	$V_{CC} = 5.5\text{ V},$ One input at 3.4 V, Other inputs at $V_{CC}$ or GND	Data inputs	Outputs enabled		1		1.5		1	mA
			Outputs disabled		0.05		1		0.05	
		Control inputs		1.5		1.5		1.5		
$C_i$	$V_I = 2.5\text{ V or }0.5\text{ V}$				7					pF
$C_o$	$V_O = 2.5\text{ V or }0.5\text{ V}$				7					pF

† All typical values are at  $V_{CC} = 5\text{ V}$ .

‡ On products compliant to MIL-STD-883, Class B, this parameter does not apply.

§ The parameters  $I_{OZH}$  and  $I_{OZL}$  include the input leakage current.

¶ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

# This is the increase in supply current for each input that is at the specified TTL voltage level rather than  $V_{CC}$  or GND.

**PRODUCT PREVIEW**



## **IMPORTANT NOTICE**

Texas Instruments (TI) reserves the right to make changes to its products or to discontinue any semiconductor product or service without notice, and advises its customers to obtain the latest version of relevant information to verify, before placing orders, that the information being relied on is current.

TI warrants performance of its semiconductor products and related software to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

Certain applications using semiconductor products may involve potential risks of death, personal injury, or severe property or environmental damage ("Critical Applications").

**TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, INTENDED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT APPLICATIONS, DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS.**

Inclusion of TI products in such applications is understood to be fully at the risk of the customer. Use of TI products in such applications requires the written approval of an appropriate TI officer. Questions concerning potential risk applications should be directed to TI through a local SC sales office.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards should be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein. Nor does TI warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used.